TPS61240EVM-360 User's Guide

This user's guide describes the characteristics, operation, and use of the TPS61240EVM-360 evaluation module (EVM). This EVM demonstrates three individual configurations of the Texas Instruments TPS61240 3.5-MHz, high-efficiency, synchronous step-up converter capable of supplying up to 450 mA of output current. Input voltage range is 2.3 V to 5.5 V and output voltage is fixed at 5 V. This user's guide includes setup instructions, schematic diagrams, a bill of materials, and printed-circuit board layout drawings for the evaluation module.

Contents

List of Figures

List of Tables

1 Introduction

The Texas Instruments TPS61240EVM-360 evaluation module helps designers evaluate the operation and performance of the TPS61240 device. These devices are high-efficiency, small size, step-up boost converters that switch at 3.5 MHz.

The EVM contains three independent dc/dc converters. Reference designators for the U11 circuit all begin with 1, the U21 circuit all begin with 2, and the U31 circuit all begin with 3 (Table 1). The devices are a fixed 5-V output. .

Table 1. Device and Package Configurations

Converter	Integrated Circuit	Package
U11	TPS61240DRV	6-QFN
U21	TPS61240YFF	6-WCSP
U31	TPS61240YFF	6-WCSP

Converter U11 is the QFN layout with the enable function controlled through JP11. This circuit has sense lines for accurate monitoring of Vin and Vout, connectors J12 and J15, respectively. For additional filtering for the input power lines, a place has been provided for a capacitor, C13. The recommended value is 22 µF. Converter U21 is a chip scale layout for the smallest area. The user does not have control of the enable function, which is connected to Vin. Converter U31 is a chip scale layout that demonstrates the use of an output diode for input overvoltage protection and diode ORing. Enable function is available on this circuit through JP31.

2 Setup

This section describes the jumpers and connectors on the EVM as well as how to properly connect, set up, and use the TPS61240EVM-360.

2.1 Input/Output Connector Descriptions

2.1.1 U11 Circuit J11 and J13 – Input Voltage

This is the positive and return input connection to U11 converter, J11 positive, and J13 return. Twist the leads to the input supply, and keep them as short as possible to minimize EMI transmission.

2.1.2 U11 Circuit J14 and J16 – Output Voltage

This is the positive and return output connection to U11 converter, J14 positive, and J16 return.

2.1.3 U11 Circuit J12 and J15 – Sense Lines

This connector provides monitoring for input voltage, J12. For monitoring output voltage, J15 is provided. Do not use the J12 and J15 for input or output current because the trace width is small.

2.1.4 U11 Circuit JP11 – EN

This jumper turns U11 on and off . To enable the converter, install a shorting jumper between ON and EN. To disable the converter, install a shorting jumper between EN and OFF.

2.1.5 U21 Circuit TP21 and TP23 – Input Voltage

This is the positive and return input connection to the U21 converter, TP21 positive and TP23 return. Twist the leads to the input supply, and keep them as short as possible to minimize EMI transmission.

2.1.6 U21 Circuit TP22 and TP24 – Output Voltage

This is the positive and return output connection to the U21 converter, J22 positive, and J24 return.

2.1.7 U31 Circuit TP31 and TP33 – Input Voltage

This is the positive and return input connection to the U31 converter, TP31 positive, and TP33 return. Twist the leads to the input supply, and keep them as short as possible to minimize EMI transmission.

2.1.8 U31 Circuit TP32 and TP34 – Output Voltage

This is the positive and return output connection to the U31 converter, J32 positive, and J34 return.

2.1.9 U31 Circuit JP31 – EN

This jumper turns U31 on and off . To enable the converter, install a shorting jumper between ON and EN. To disable the converter, install a shorting jumper between EN and OFF.

2.2 Setup

All three converters are designed to use an input voltage between 2.3 V and 5.5 V. Connect the input voltage power supply and output according to Table 2.

Table 2. Input and Output Connections

Converter No.	Signal	Connection
U11	Positive Input Voltage	J11
	Input Voltage Return	J13
	Positive Output Voltage	J14
	Output Voltage Return	J16
U21	Positive Input Voltage	TP21
	Input Voltage Return	TP23
	Positive Output Voltage	TP22
	Output Voltage Return	TP24
U31	Positive Input Voltage	TP31
	Input Voltage Return	TP33
	Positive Output Voltage	TP32
	Output Voltage Return	TP34

2.3 Operation

JP11 and JP31 must be configured for proper operation of converter U11 and U31. Use a shorting block to set JP11 and JP31 to the desired configurations. For JP11, jump the EN pin to the ON pin to enable and operate the converter U11. Jumping the EN pin to the OFF pin disables the converter.

For JP31, jump the EN pin to the ON pin to enable and operate the converter U31. Jumping the EN pin to the OFF pin disables the converter.

The EN pin must be jumped to one of these positions. Do not leave the EN pin floating.

Converter U21 does not require any additional configuration for operation other than input power. This converter is hard-wired to always be enabled.

2.4 Test Results

See the Typical Characteristics section of the TPS61240 data sheet. This EVM uses the same inductors and similar capacitors as those used for characterization in the data sheet. Performance is consistent with that shown in the data sheet.

3 Board Layout

This section provides the TPS61240EVM-360 board layout and illustrations.

Board layout is critical for all high-frequency, switch-mode power supplies. Figure 1, Figure 2, and Figure 3 show the board layout for the TPS61240EVM-360 printed-circuit board. The nodes with high-switching frequencies and currents are kept as short as possible to minimize trace inductance. High-impedance inputs to the TPS61240, such as the Vout pin, have traces that are shielded by ground traces and planes. Careful attention has been given to the routing of high-frequency current loops and a single-point grounding scheme is used. See the data sheet for specific layout guidelines.

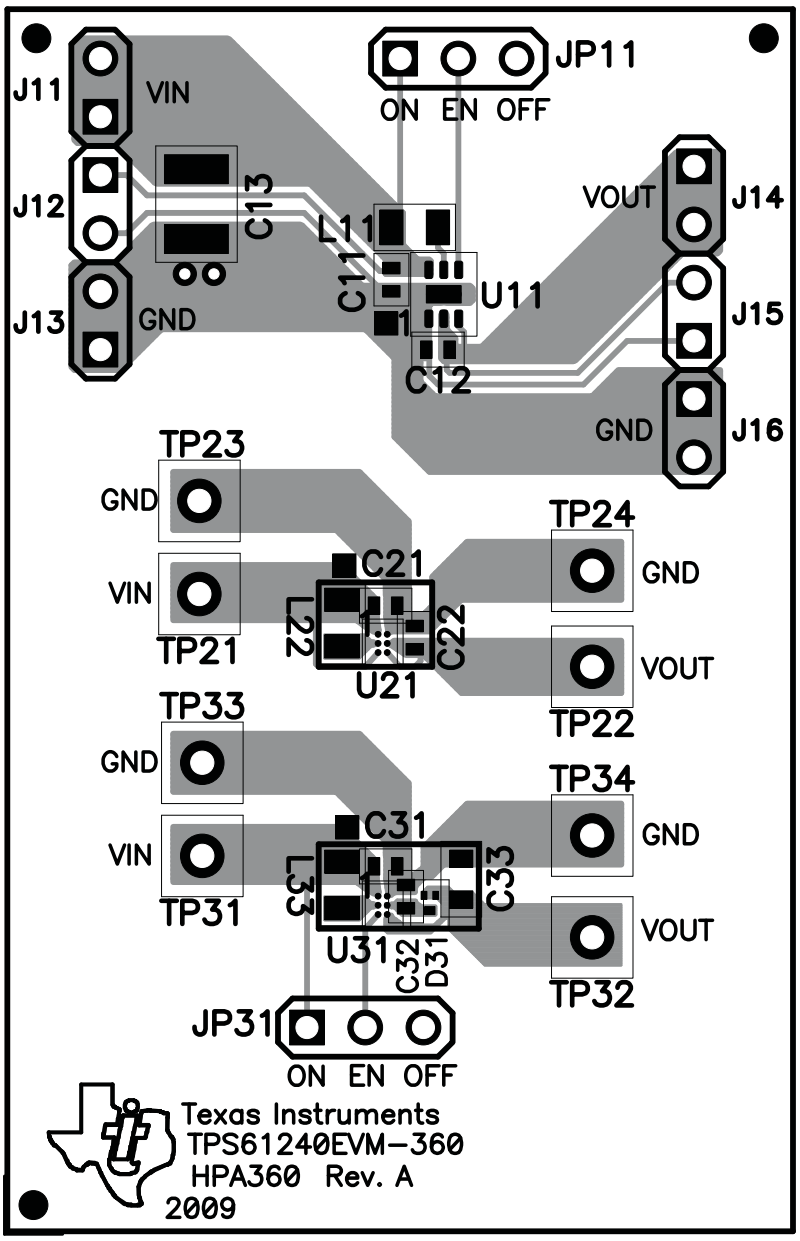

Figure 1. Assembly Layer

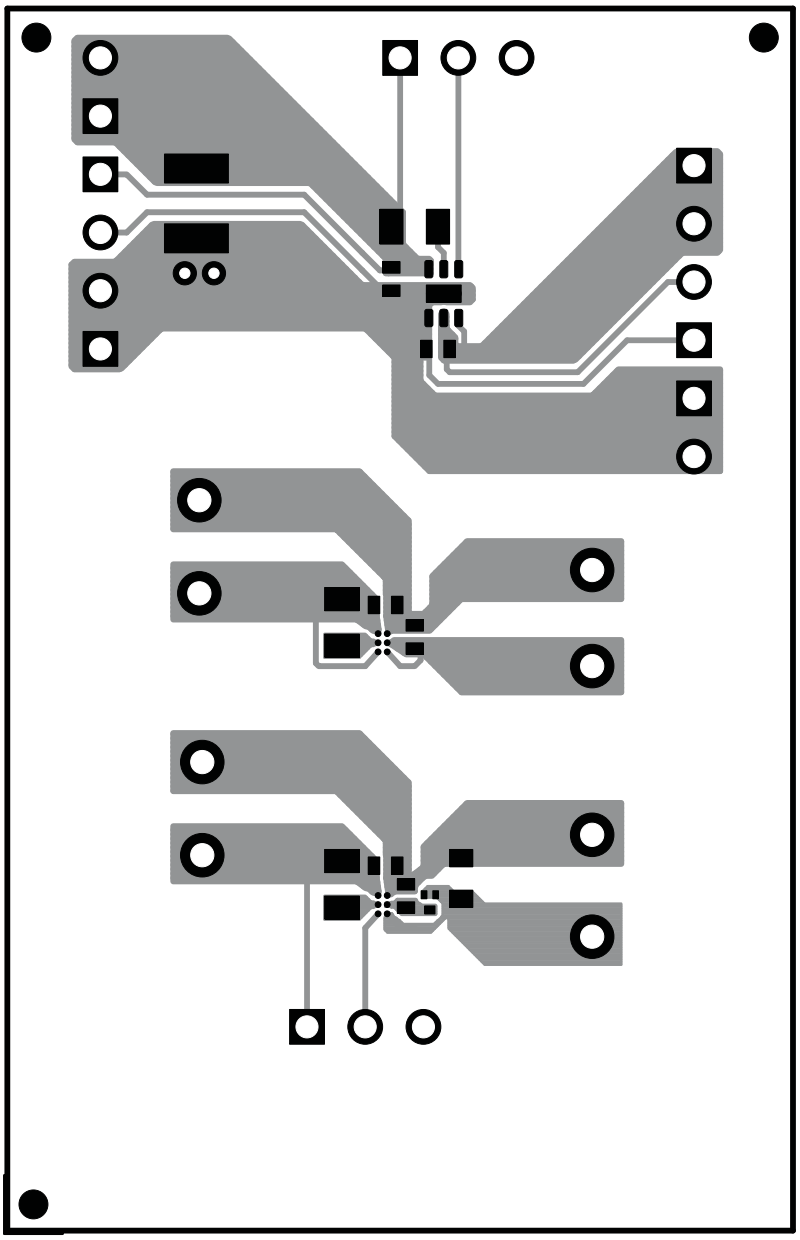

Figure 2. Layer One

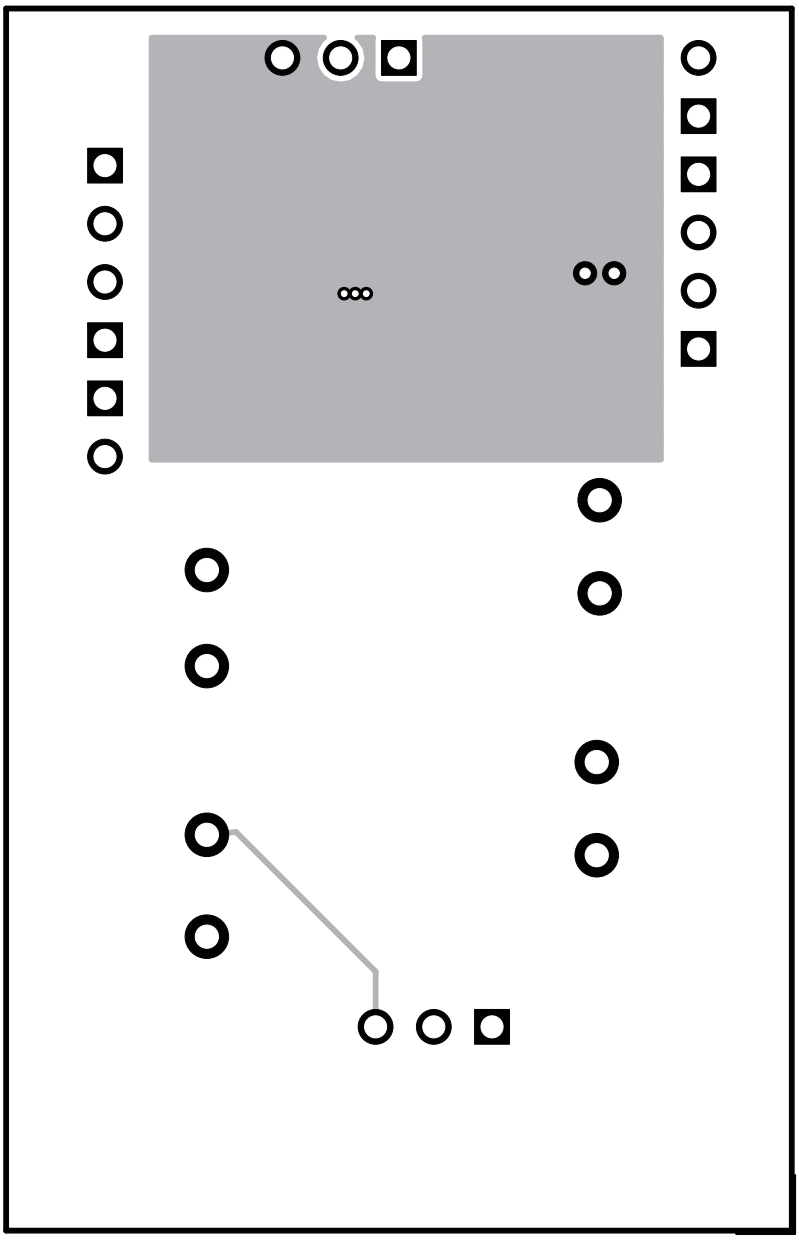

Figure 3. Bottom Layer

4 Schematic and Bill of Materials

This section provides the TPS61240EVM-360 schematics and bill of materials.

4.1 Schematics

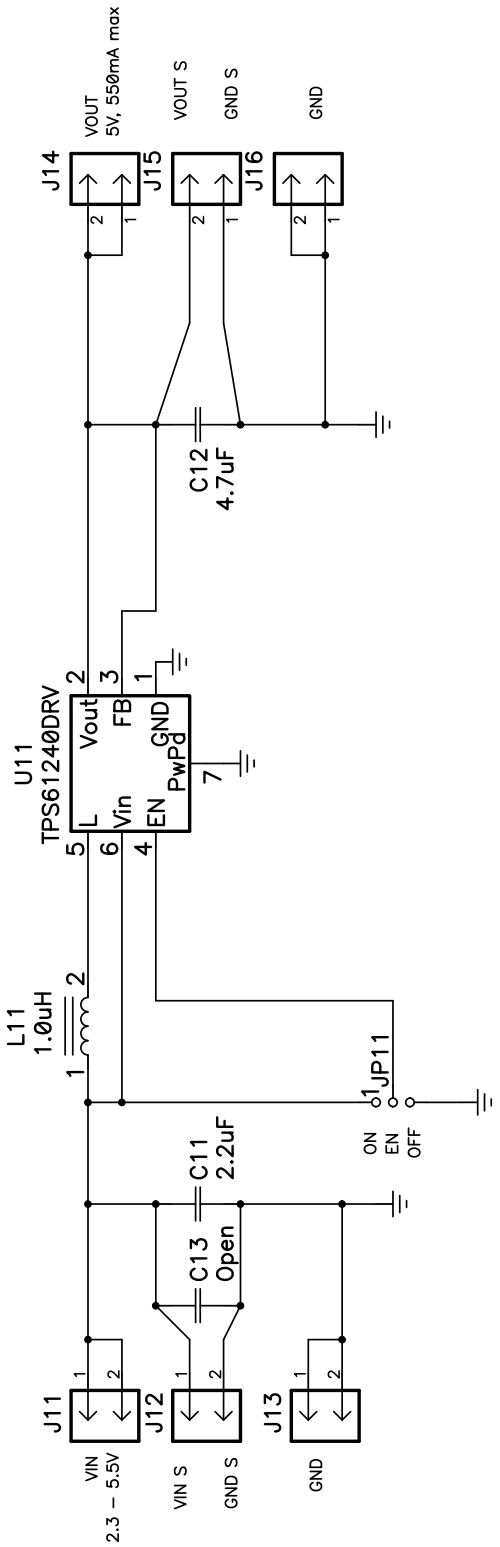

Figure 4. TPS61240EVM-360 Schematic – U11 Configuration

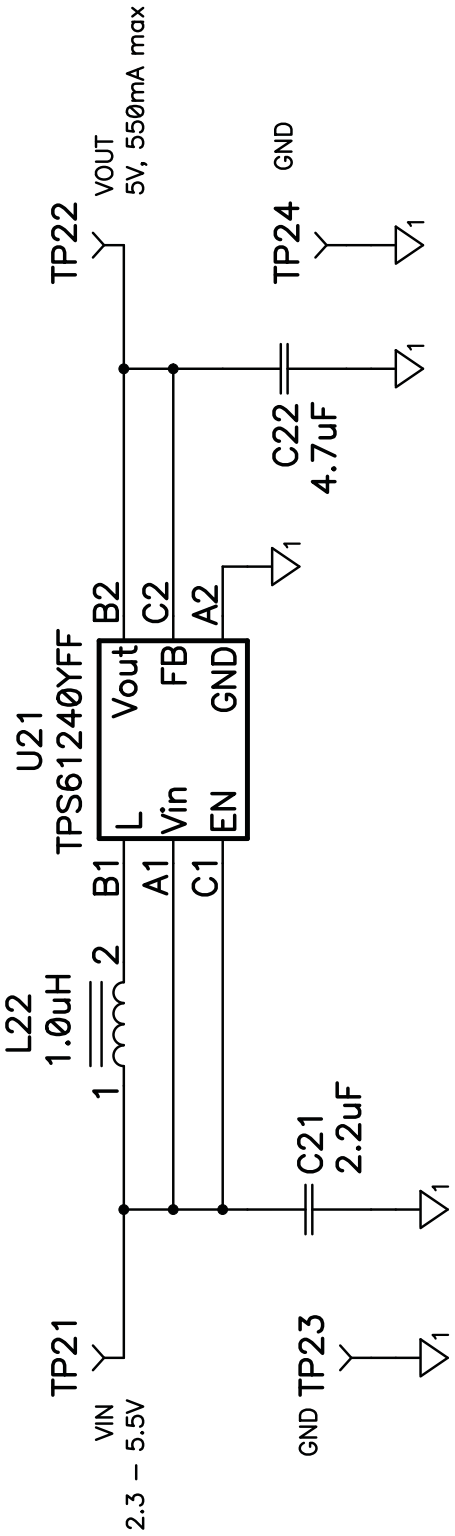

Figure 5. TPS61240EVM-360 Schematic – U21 Configuration

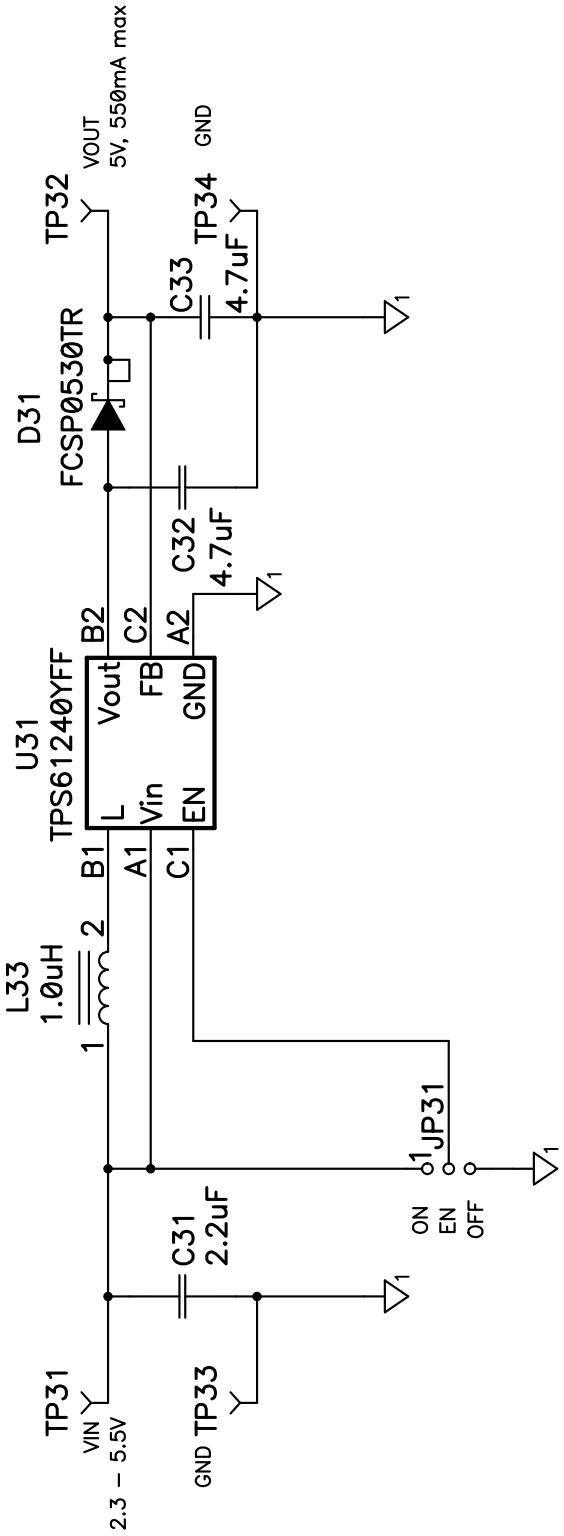

Figure 6. TPS61240EVM-360 Schematic – U31 Configuration

4.2 Bill of Materials

Table 3. TPS61240EVM-360 Bill of Materials

Count	RefDes	Value	Description	Size	Part Number	MFR
3	C11, C21, C31	2.2µF	Capacitor, Ceramic, 6.3V, X5R, 20%	0402	JDK105BJ225MV	Taiyo Yuden
3	C12, C22, C32	4.7µF	Capacitor, Ceramic, 6.3V, X5R, 20%	0402	JDK105BJ475MV	Taiyo Yuden
1	C13	Open	Capacitor, Ceramic, 6.3V, X5R, 20%	1210	Std	Std
1	C33	4.7µF	Capacitor, Ceramic, 6.3V, X5R, 20%	0603	Std	Std
1	D31	FCSP0530TR	Diode, Schottky Barrier, 0.5A, 30V	FlipKY	FCSP0530TR	Vishay
6	J11, J12, J13, J14, J15, J16	PEC02SAAN	Header, Male 2-pin, 100mil spacing	0.100 inch x 2	PEC02SAAN	Sullins
2	JP11, JP31	PEC03SAAN	Header, 3 pin, 100mil spacing	0.100 x 3	PEC03SAAN	Sullins
3	L11, L22, L33	1.0µH	Inductor, SMT, 0.9A, 180milliohm	2012	MDT2012-CH1R0A	TOKO
4	TP21, TP22, TP31, TP32	Red TP	Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100 inch	5000	Keystone
4	TP23, TP24, TP33, TP34	Black TP	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
1	U11	TPS61240DRV	IC, 200mA High Fq. Step-up Converter	TDFN	TPS61240DRV	TI
2	U21, U31	TPS61240YFF	IC, 200mA High Fq. Step-up Converter	WCSP-6	TPS61240YFF	TI
2	—		Shunt, 100-mil, Black	0.100	929950-00	3M
1			PCB	2.1"x 1.35"x 0.062"	HPA360	Any

5 Related Documentation From Texas Instruments

TPS61240, 3.5-MHz High Efficiency Step-Up Converter data sheet (SLVS806)

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 2.3 V to 5.5 V and the output voltage range of 5 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 25°C. The EVM is designed to operate properly with certain components above 25°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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